

Features

- High Voltage
- Industrial Standard Package
- Thick Al metal die and double stick bonding
- Thick copper baseplate
- UL E78996 approved
- 3500V_{RMS} isolating voltage

Benefits

- Up to 1600V
- Full compatible TO-240AA
- High Surge capability
- Easy Mounting on heatsink
- Al₂O₃ DBC insulator
- Heatsink grounded

45 A
60 A

Mechanical Description

The Generation V of Add-A-pak module combine the excellent thermal performance obtained by the usage of Direct Bonded Copper substrate with superior mechanical ruggedness, thanks to the insertion of a solid Copper baseplate at the bottom side of the device. The Cu baseplate allow an easier mounting on the majority of heatsink with increased tolerance of surface roughness and improve thermal spread. The Generation V of AAP module is manufactured without hard mold, eliminating in this way any possible direct stress on the leads.

The electrical terminals are secured against axial pull-out: they are fixed to the module housing via a click-stop feature already tested and proved as reliable on other IR modules.

Electrical Description

These modules are intended for general purpose high voltage applications such as high voltage regulated power supplies, lighting circuits, temperature and motor speed control circuits, UPS and battery charger.

Major Ratings and Characteristics

Parameters	IRKU/V41	IRKU/V56	Units
$I_{T(AV)}$ @ 85°C	45	60	A
$I_{T(RMS)}$	70	95	A
I_{TSM} @ 50Hz	850	1310	A
@ 60Hz	890	1370	A
I^2t @ 50Hz	3.61	8.50	KA ² s
@ 60Hz	3.30	7.82	KA ² s
$I^2\sqrt{t}$	36.1	85.0	KA ² √s
V_{RRM} range	400 to 1600		V
T_{STG}	- 40 to 125		°C
T_J	- 40 to 125		°C



ELECTRICAL SPECIFICATIONS**Voltage Ratings**

Type number	Voltage Code	V_{RRM} , maximum repetitive peak reverse voltage V	V_{RSM} , maximum non-repetitive peak reverse voltage V	V_{DRM} , max. repetitive peak off-state voltage, gate open circuit V	I_{RRM} I_{DRM} 125°C mA
IRKU/V41, 56	04	400	500	400	15
	08	800	900	800	
	12	1200	1300	1200	
	16	1600	1700	1600	

On-state Conduction

Parameters	IRKU/V41	IRKU/V56	Units	Conditions		
$I_{T(AV)}$ Max. average on-state current	45	60	A	180° conduction, half sine wave, $T_C = 85^{\circ}\text{C}$		
$I_{T(RMS)}$ Max. RMS on-state current @ T_C	70	95		DC		
I_{TSM} Max. peak, one cycle non-repetitive on-state current	82	80	°C			
	850	1310	A	t=10ms	No voltage	Sinusoidal half wave, Initial $T_J = T_J$ max.
	890	1370		t=8.3ms	reapplied	
	715	1100		t=10ms	100% V_{RRM}	
	750	1150		t=8.3ms	reapplied	
	940	1450		t=10ms	$T_J = 25^{\circ}\text{C}$,	no voltage reapplied
985	1520	t=8.3ms				
I^2t Max. I^2t for fusing	3.61	8.56	KA^2s	t=10ms	No voltage	Initial $T_J = T_J$ max.
	3.30	7.82		t=8.3ms	reapplied	
	2.56	6.05		t=10ms	100% V_{RRM}	
	2.33	5.53		t=8.3ms	reapplied	
	4.42	10.05		t=10ms	$T_J = 25^{\circ}\text{C}$,	
	4.03	9.60		t=8.3ms	no voltage reapplied	
$I^2\sqrt{t}$ Max. $I^2\sqrt{t}$ for fusing (1)	36.1	85.6	$\text{KA}^2\sqrt{\text{s}}$	$t=0.1$ to 10ms, no voltage reapplied		
$V_{T(TO)}$ Max. value of threshold voltage (2)	0.88	0.85	V	Low level (3)		$T_J = T_J$ max
	0.91	0.88		High level (4)		
r_t Max. value of on-state slope resistance (2)	5.90	3.53	$\text{m}\Omega$	Low level (3)		$T_J = T_J$ max
	5.74	3.41		High level (4)		
V_{TM} Max. peak on-state voltage	1.81	1.54	V	$I_{TM} = \pi \times I_{T(AV)}$		$T_J = 25^{\circ}\text{C}$
				$I_{FM} = \pi \times I_{F(AV)}$		
di/dt Max. non-repetitive rate of rise of turned on current	150		$\text{A}/\mu\text{s}$	$T_J = 25^{\circ}\text{C}$, from 0.67 V_{DRM} , $I_{TM} = \pi \times I_{T(AV)}$, $I_g = 500\text{mA}$, $t_r < 0.5 \mu\text{s}$, $t_p > 6 \mu\text{s}$		
I_H Max. holding current	200		mA	$T_J = 25^{\circ}\text{C}$, anode supply = 6V, resistive load, gate open circuit		
I_L Max. latching current	400			$T_J = 25^{\circ}\text{C}$, anode supply = 6V, resistive load		

(1) I^2t for time $t_X = I^2t / t \times \sqrt{t_X}$

(3) $16.7\% \times \pi \times I_{AV} < I < \pi \times I_{AV}$

(2) Average power = $V_{T(TO)} \times I_{T(AV)} + r_t \times (I_{T(RMS)})^2$

(4) $I > \pi \times I_{AV}$

Triggering

Parameters		IRKU/V41	IRKU/V56	Units	Conditions	
P _{GM}	Max. peak gate power	10	10	W		
P _{G(AV)}	Max. average gate power	2.5	2.5			
I _{GM}	Max. peak gate current	2.5	2.5	A		
-V _{GM}	Max. peak negative gate voltage	10		V	Anode supply = 6V resistive load	
V _{GT}	Max. gate voltage required to trigger	4.0				
		2.5				
		1.7				
I _{GT}	Max. gate current required to trigger	270		mA	Anode supply = 6V resistive load	
		150				
		80				
V _{GD}	Max. gate voltage that will not trigger	0.25		V	T _J = 125°C, rated V _{DRM} applied	
I _{GD}	Max. gate current that will not trigger	6		mA	T _J = 125°C, rated V _{DRM} applied	

Blocking

Parameters	IRKU/V41, 56	Units	Conditions
I_{RRM} Max. peak reverse and off-state leakage current at V_{RRM} , V_{DRM}	15	mA	$T_J = 125^\circ\text{C}$, gate open circuit
V_{INS} RMS isolation voltage	2500 (1 min) 3500 (1 sec)	V	50 Hz, circuit to base, all terminals shorted
dv/dt Max. critical rate of rise of off-state voltage (5)	500	V/ μs	$T_J = 125^\circ\text{C}$, linear to 0.67 V_{DRM} , gate open circuit

(5) Available with $dv/dt = 1000\text{V}/\mu\text{s}$, to complete code add S90 i.e. IRKU41/16AS90.

Thermal and Mechanical Specifications

Parameters		IRKU/V41	IRKU/V56	Units	Conditions
T _J	Junction operating temperature range	- 40 to 125		°C	
T _{stg}	Storage temper. range	- 40 to 125			
R _{thJC}	Max. internal thermal resistance, junction to case	0.23	0.20	K/W	Per module, DC operation
R _{thCS}	Typical thermal resistance case to heatsink	0.1			Mounting surface flat, smooth and greased
T	Mounting torque ± 10% to heatsink	5		Nm	A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound
	busbar	3			
wt	Approximate weight	110 (4)		g (oz)	
Case style		TO-240AA		JEDEC	

ΔR Conduction (per Junction)

(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

Devices	Sine half wave conduction					Rect. wave conduction					Units
	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	
IRKU/V41	0.11	0.13	0.17	0.23	0.34	0.09	0.14	0.18	0.23	0.34	$^\circ\text{C}/\text{W}$
IRKU/V56	0.09	0.11	0.13	0.18	0.27	0.07	0.11	0.14	0.19	0.28	

IRKU/V41, 56 Series

Bulletin I27134 rev. E 10/02

International
IRF Rectifier

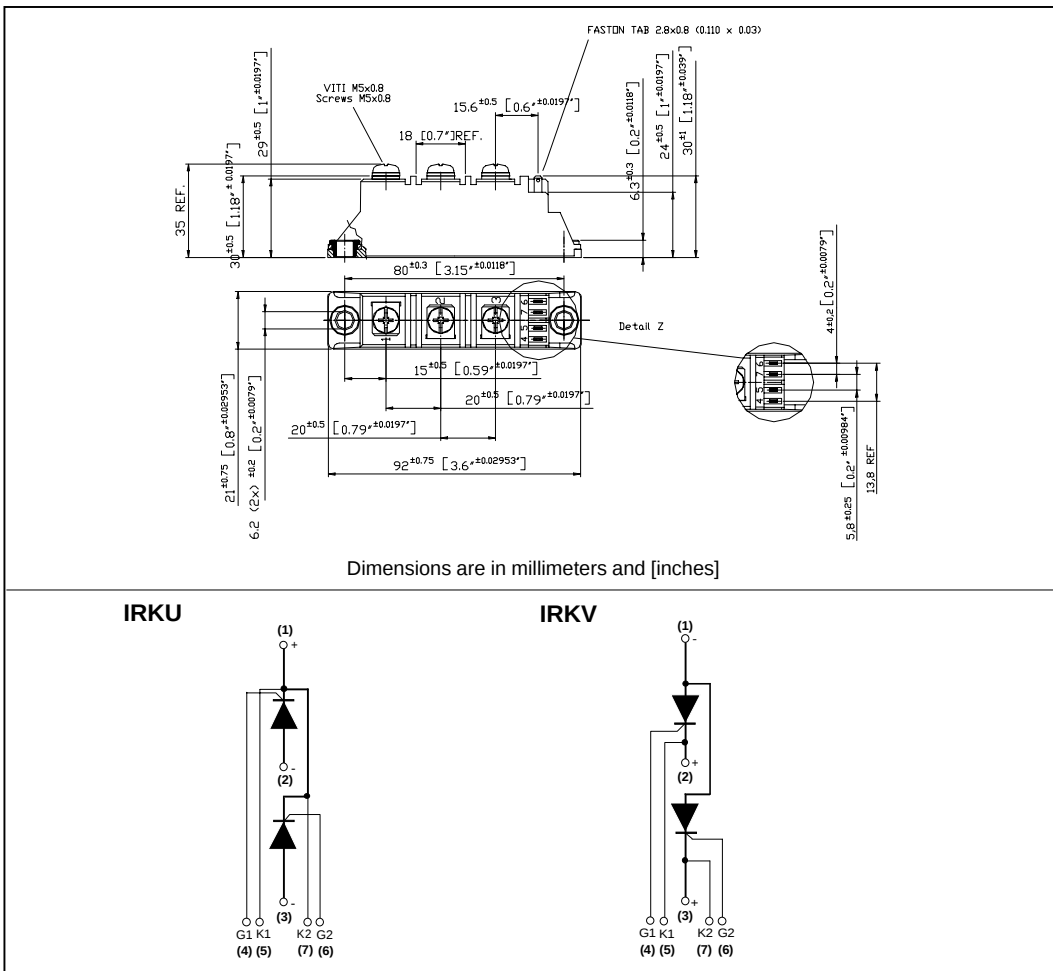
Ordering Information Table

Device Code					
1	2	3	4	5	6
IRK	U	56	/	16	A S90
1	- Module type				
2	- Circuit configuration (See Circuit Configuration table below)				
3	- Current code **				
4	- Voltage code (See Voltage Ratings table)				
5	- A : Gen V				
6	- dv/dt code: S90 = dv/dt 1000 V/ μ s No letter = dv/dt 500 V/ μ s				

IRK.57 types
With no auxiliary cathode

** Available with no auxiliary cathode.
To specify change: 56 to 57
41 to 42
e.g. : IRKU57/16A etc.

Outline Table



NOTE: To order the Optional Hardware see Bulletin I27900

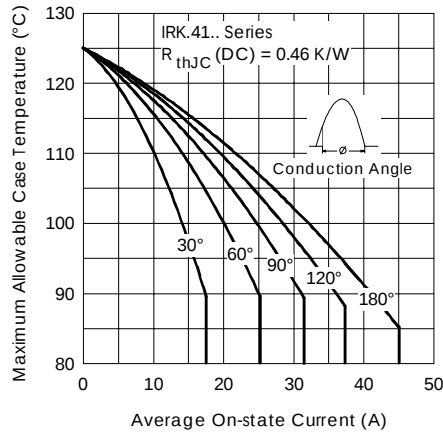


Fig. 1 - Current Ratings Characteristics

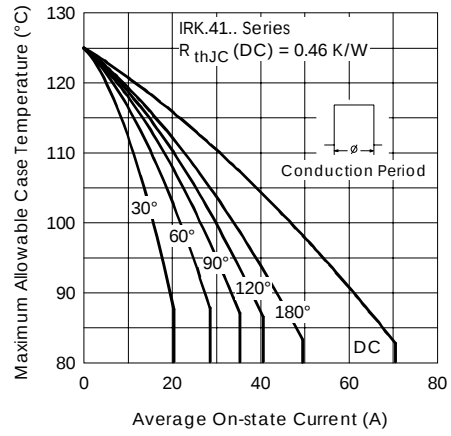


Fig. 2 - Current Ratings Characteristics

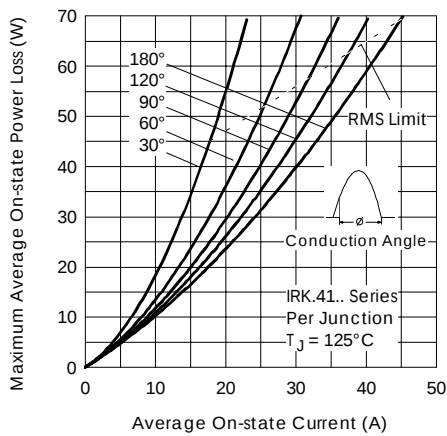


Fig. 3 - On-state Power Loss Characteristics

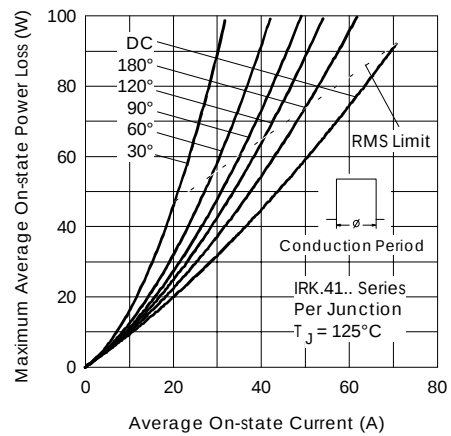


Fig. 4 - On-state Power Loss Characteristics

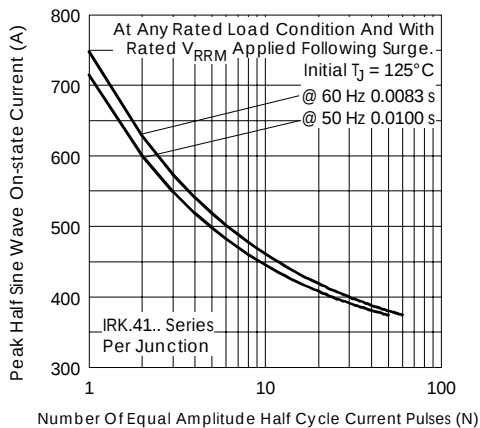


Fig. 5 - Maximum Non-Repetitive Surge Current

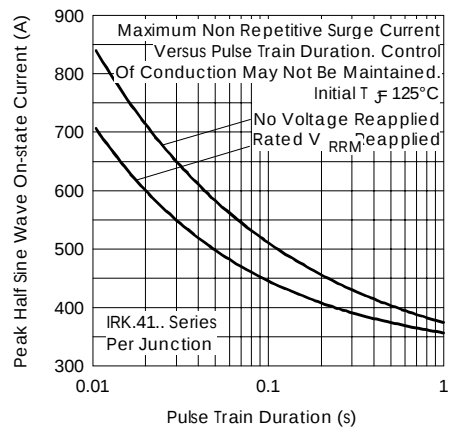


Fig. 6 - Maximum Non-Repetitive Surge Current

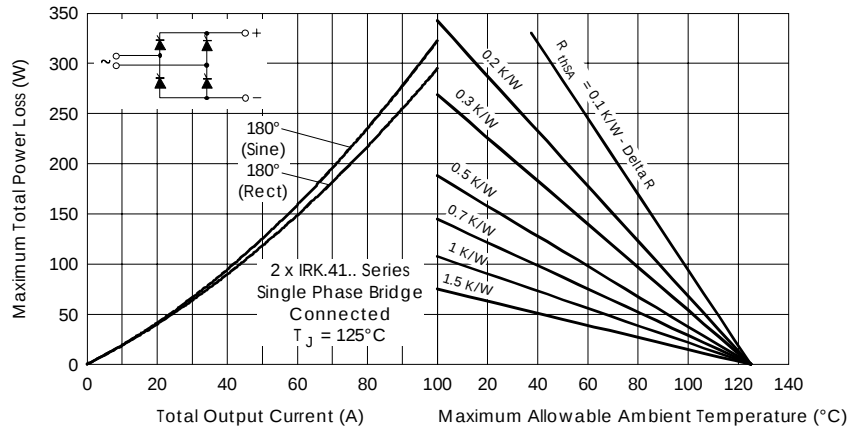


Fig. 7 - On-state Power Loss Characteristics (Single Phase Bridge IRKU+IRKV)

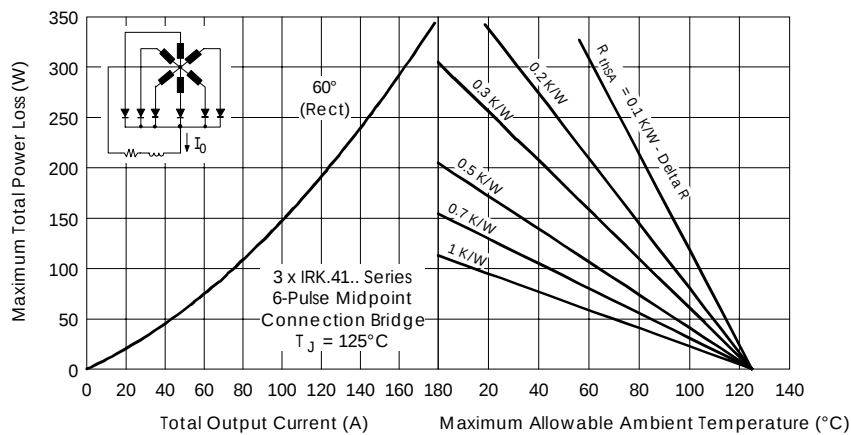


Fig. 8 - On-state Power Loss Characteristics

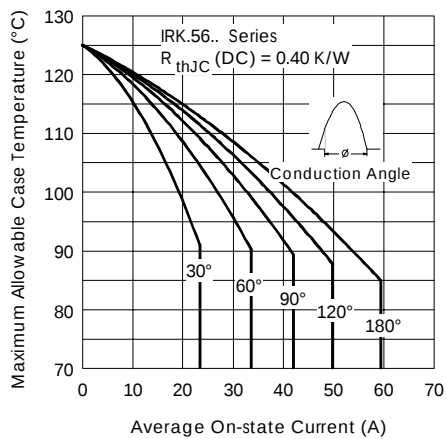


Fig. 9 - Current Ratings Characteristics

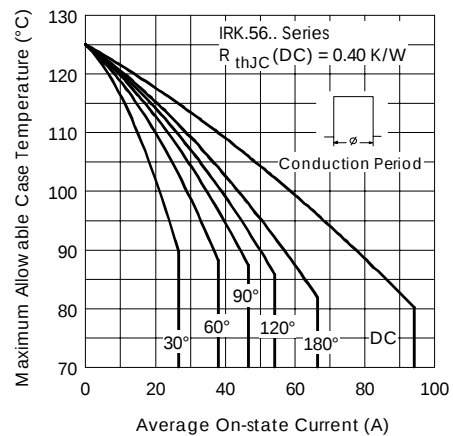


Fig. 10 - Current Ratings Characteristics

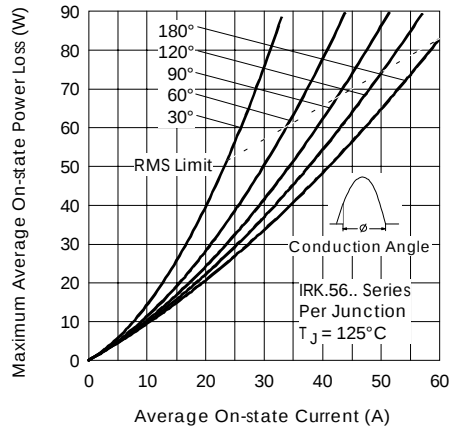


Fig. 11 - On-state Power Loss Characteristics

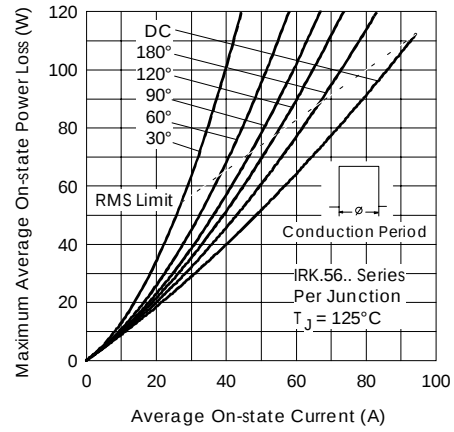


Fig. 12 - On-state Power Loss Characteristics

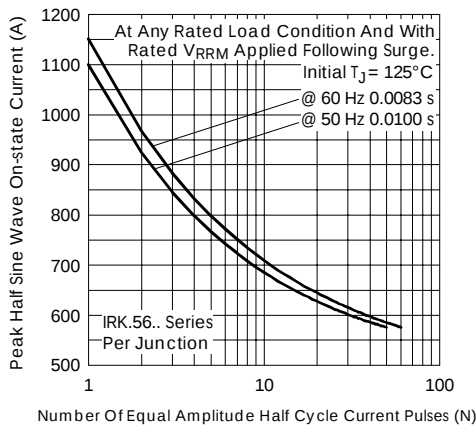


Fig. 13 - Maximum Non-Repetitive Surge Current

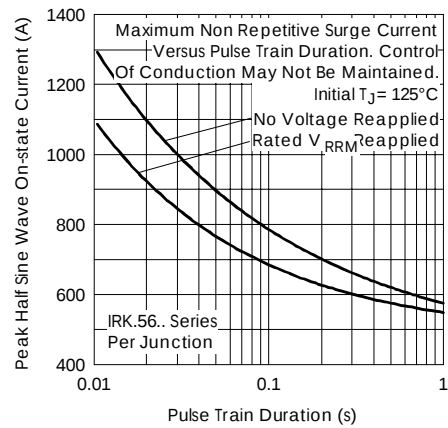


Fig. 14 - Maximum Non-Repetitive Surge Current

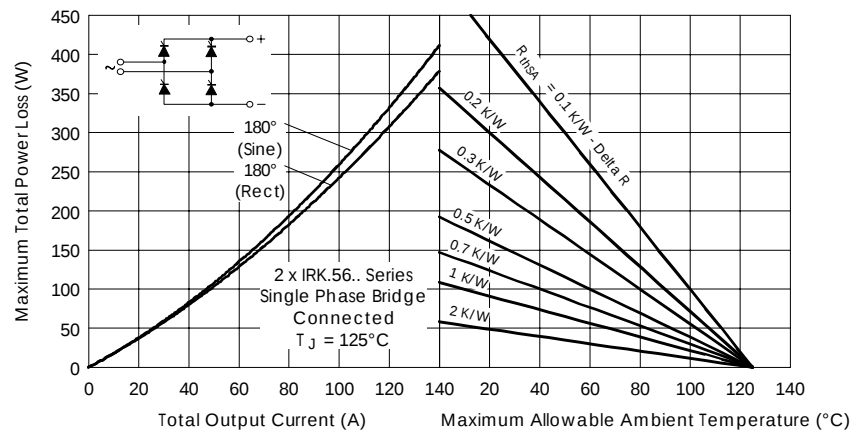


Fig. 15 - On-state Power Loss Characteristics (Single Phase Bridge IRKU+IRKV)

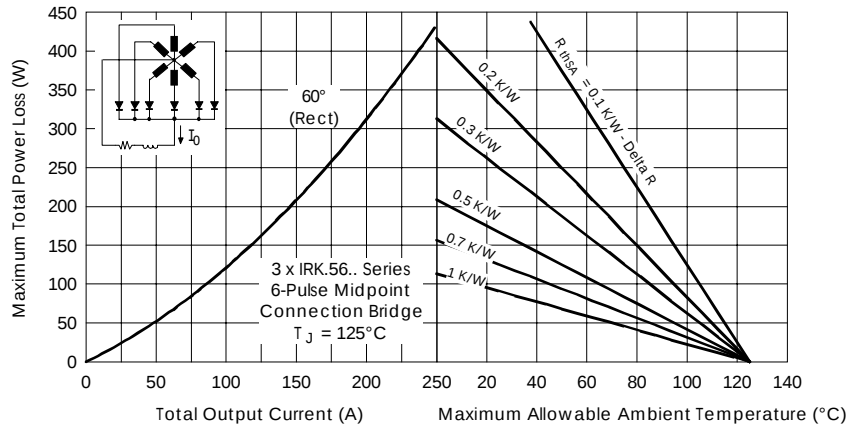


Fig. 16 - On-state Power Loss Characteristics

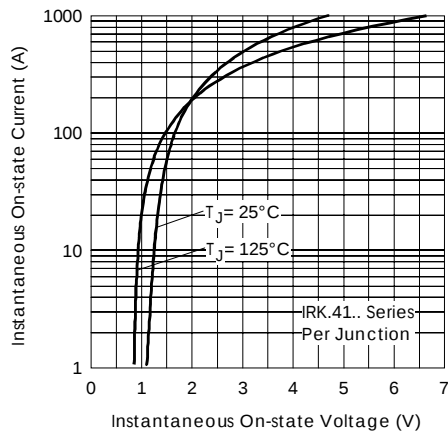


Fig. 17 - On-state Voltage Drop Characteristics

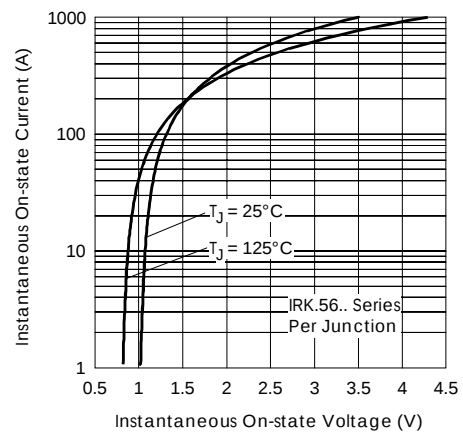


Fig. 18 - On-state Voltage Drop Characteristics

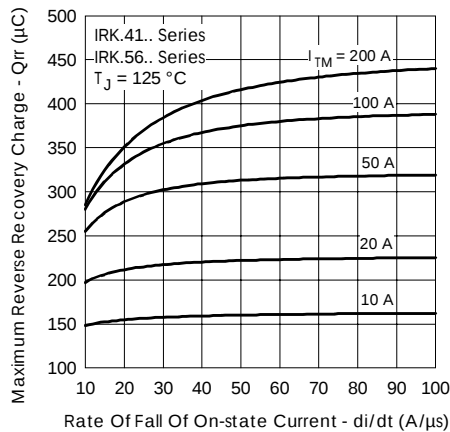


Fig. 19 - Recovery Charge Characteristics

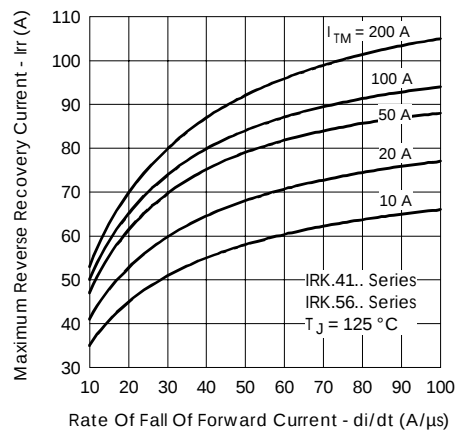


Fig. 20 - Recovery Current Characteristics

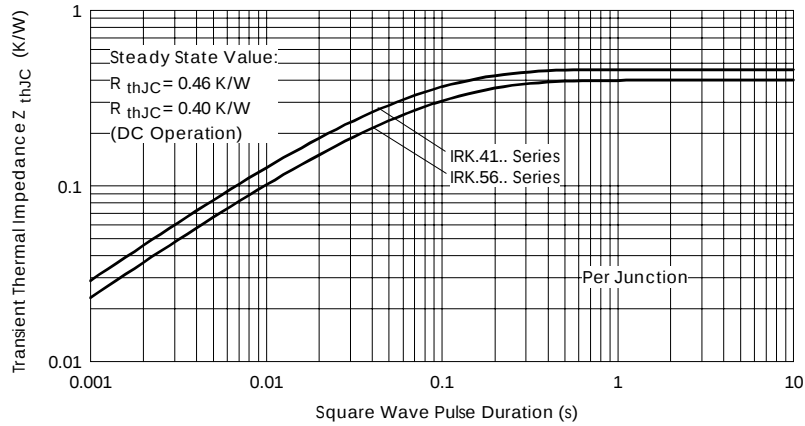


Fig. 21 - Thermal Impedance Z_{thJC} Characteristics

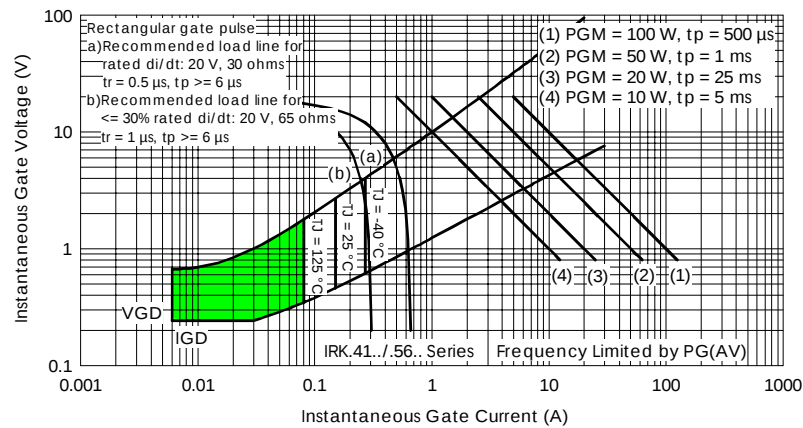


Fig. 22 - Gate Characteristics

Data and specifications subject to change without notice.
 This product has been designed and qualified for Industrial Level.
 Qualification Standards can be found on IR's Web site.